**FORM PTO-1595** 

(Rev. 6-93)



OVER SHEET U.S. DEPARTMENT OF COMMERCE

OMB No. 0651-0011	(exp. 4/94)	102297707	2001P09994US	
To the Honorable Commissioner of Patents and Trademarks:			Please record the attached original documents or copy thereof	
Name of conveying party(ies):			Name and address of receiving party(ies)	
Infineon Technologies North America Corp.			Name: Infineon Technologies AG	
	11-2	26-02	Internal Address:	
Additional name(s) of conveying party(ies) attached?Yes _X_No				
3. Nature of conveyance:			Street Address: <u>St. Martin-Str. 53</u>	
_X_ Assignment Merger			81541Munich Germany	
Security Agreement Change of Name		of Name	City:State:ZIP:	
Other			Additional name(s) & address(es) attached? Yes _X_ No	
Execution Date: November 15, 2002				
4. Application number(s) or patent number(s):				
4. Application number(s) or patent number(s):  If this document is being filed together with a new application, the execution date of the application is:  A. Patent Application No.(s)  B. Patent No.(s)				
A. Patent Application No.(s)			B. Patent No.(s)	
09/867,518		i		
			Additional numbers attached?Yes _X dvo	
Name and address of party to whom correspondence concerning document should be mailed:		ondence	6. Total number of applications and patents involved: one	
Name: Elsa Keller Internal Address:				
			7. Total Fee (37 CFR 3.41) \$ 40.00	
Siemens Co	Siemens Corporation  Intellectual Property Department		Enclosed	
intellectual P			X Authorized to be charged to deposit account	
Street Address:	186 Wood Avenue South			
City: Iselin	State: NJ ZIP: 0883	<u>30</u>	8. Deposit Account No.	
77.000 = 41.4			<u>19-2179</u>	
DO NOT USE THIS SPACE				
9. Statement and signature To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.  Stanton C. Braden, Esq. Reg. No: 32,556 Name of Person Signing Signature Date				
Total number of pages including cover sheet, attachments, and document: 3				
	1	1		

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**PATENT** 

**REEL: 013524 FRAME: 0579** 

Atty.Dckt.No.: 2001P09994US

## **ASSIGNMENT**

For good and valuable consideration, We, Infineon Technologies North America Corp., hereinafter referred to as Assignor, hereby sells, assigns and transfers to Infineon Technologies AG, a corporation, organized and existing under the laws of Germany, having its principal place of business at St. Martin Str. 53, 81541 Munich, Germany,

hereinafter referred to as Assignee, its successors, assigns and legal representatives, the entire right, title and interest, in and for the United States and all foreign countries, in and to any and all inventions which are disclosed in the application for United States Letters patent,

Serial No.: 09/867,518 Filed: May 31, 2001

and entitled: Method For Removing Polysilane From A Semiconductor Without Stripping

in and to said application and all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said inventions; and in and to all original and reissued patents which have been or shall be filed in the United States and all foreign countries on said inventions;

Assignor agrees that Assignee may apply for and receive Letters Patent for said inventions in its own name;

Assignor agrees that, at the request of the Assignee and, without charge to but at the expense of said Assignee, Assignor will carry out in good faith the intent and purpose of this Assignment; execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said inventions; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to Assignee, all facts known to the undersigned relating to said inventions and the history thereof; and generally do everything possible which Assignee shall consider desirable for aiding in securing and mainlining proper patent protection for said inventions and for vesting title to said inventions, and all applications for patents and all patents on inventions in said Assignee;

PATENT REEL: 013524 FRAME: 0580 Covenant with Assignee that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

Infineon Technologies North America Corp.

Gregory Pibbes

Its Secretary Duly Authorized

State of <u>California</u>)
County of <u>Santa Clara</u>)

On this 15 day of blember 2002, before me, the undersigned Notary Public, duly commissioned and sworn, personally appeared Gregory Bibbes,

personally known to me
proved to me on the basis of satisfactory evidence to be the person(s) whose name(s) \_\_\_\_\_\_ subscribed to the within instrument, and acknowledged that executed it in his authorized capacity on behalf of the corporation named therein, and that by his signature on the instrument that such corporation executed the same.

WITNESS my hand and official seal.

Notary Public

RECORDED: 11/26/2002

ELAINE GONZALES
Comm. # 1268080
NOTARY PUBLIC-CALIFORNIA
Santa Clara County
My Comm. Expires June 22, 2004

PATENT REEL: 013524 FRAME: 0581